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Application Data Sheet 37 CFR 1.76			Attorney Dock	et Numbe				
			Application Nu			Not assigned		
Title of Invention Mold, Method of Forming the Same, and Method of Producing Polycrystalline Silicon Substrate Using the Mold								
		visional or nonprovisional app				contains the		
	oleted electronic	cified by the United States Pa cally and submitted to the Offi paper filed application.				EFS) or the		
Secrecy Order 37								
		associated with this Applic as that fall under Secrecy				rsuant to 37 CFR		
Applicant Informa	tion:							
Applicant 1								
Applicant Authori	ty 🖂	Legal Representative	under 35 U.S.C. 117		_ -	under 35 U.S.C. 118		
Prefix Given I	Name	Middle Name			Family Name	Suffix		
Youhei					Sakai			
Residence Inform	ation (Sel	ect One) 🔲 US Resid	ency 🔲 Non US R	Residency	Active US Mili	tary Service		
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Citizenship under	37 CFR 1	.41(b) Japan						
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All Inventors Must Be	e Listed – A	dditional Inventor Info	ormation blocks a	re contain	ed on the attacl	hed sheet.		
Correspondence					4			
		ber or complete th	ie Corresponde	ence Info	ormation sect	ion below.		
For further inform								
		rovided for the co	rrespondence	intormat	ion of this ap	plication.		
Customer Numbe								
Email Address	ljmccl	ure@hhlaw.com						
Application Information:								
Title of the Invention Mold, Method of Forming the Same, and Method of Producing Polycrystalline Silicon Substrate Using the Mold								
Attorney Docket Number	31872.0124	Small Entity Status Claimed			ned			
Application Type	J tility		.I					
Subject Matter								
Suggested Class			Sub Clas	ss (if any)				
Suggested Technology Center (if any)								
Total Number of Drawing Sheets (if any) 14 Suggested Figure for Publication (if any)								
Total number of Drawing Streets (II any) 14								

Application Data Sheet 37 CFR 1.76		Attorney Docket Number	81872.0124							
		Application Number	Not assigned							
Title of Invention Mold, Method of Forming the Same, and Method of Producing Polycrystalline Silicon Substrate Using the Mold										
Publication Information	tion:									
		at time of Request 37 CFR 1	.219)							
and certify that the	e invention disclosed in the attac another country, or under a mul	attached application not be publis thed application has not been and ltilateral agreement, that requires	will not be the subject of an							
Representative Info	rmation:									
information in the Application Enter either Customer Numb Number will be used for the I	Data Sheet does not constitute a per or complete the Representative Nepresentative Information during pr	rs having a power of attorney in the ap ower of attorney in the application (se lame section below. If both sections rocessing.	e 37 CFR 1.32).							
Please Select One:										
Customer Number	26021									
Domestic Priority Information:										
This section allows for the applicant to claim benefit under 35 U.S.C. 119(e), 120, 121, or 365(c). Providing this information in the application data sheet constitutes the specific reference required by 35 U.S.C. 119(e) or 120, and 37 CFR 1.78(a)(2) or CFR 1.78(a)(4), and need not otherwise be made part of the specification.										
Prior Application State	us									
Application Number	Continuity Type	Prior Application Number	Filing Date (YYYY-MM-DD)							
This application	National Phase	PCT/JP2005/001545	2005-01-27							
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Foreign Driggity Information										
This section allows for t		of foreign priority and to identify	any prior foreign							
This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes										
	required by 35 U.S.C. 119(b)									
Application Number	Country	Parent Filing Date (YYYY-MN	/I-DD) Priority Claimed							
2004-21174 Japan		2004-01-29	Yes No							
2004-96814	Japan	2004-03-29	Yes No							
			Yes No							
			Yes No							

Application Data	Shoot 27 CER 1 76	Attorney Docket Number	81872.0124		
Application Data Sheet 37 CFR 1.76		Application Number	Not assigned		
Title of Invention	Mold, Method of Forming the Same, and Method of Producing Polycrystalline Silicon Substrate Using the Mold				

Assignee Information:

		tion in the application dat to have an assignment re			ompliance with any re	quirement of part 3
Assignee	:1					
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Email Add	Iress			*	<u>.</u>	
Additional	Assigne	e Data is contained o	on the att	ached sheet.		

Signature:

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A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please								
see 37 CFR 1	.4(d) for the form of the	signature.						
Signature	Laurent	Melan	Date (YYYY-MM-DD)	2006-07-27				
First Name	Lawrence	Last Name McClure	Reg. Number	44,228				
	y							

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 23 minutes to complete, including gathering, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. **SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450**.

Application Data Sheet 37 CFR 1.76				Attorney Docket Number			81872.0124					
				Application Number				Not assigned				
Title of Invention Mold, Method of Forming the Same, and Method of Producing Polycrystalline												
Silicon Substrate Using the Mold												
Additiona	l Appli	cant Informa	tion:									
Applicant												
	Applicant Authority Inventor Legal Representative under 35 U.S.C. 117 Party of Interest under 35 U.S.C. 118											
Prefix		n Name		Name				_		y Name		uffix
	Yoshi							_	MAN	•		
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		er 37 CFR 1.4			Japan		•			-		
		of Applicant						• •				
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Applicant	3						·					
Applicant		rity Inventor	Lee	gal Represe	entative under	35 U.S.	C. 117		Party	of Interest	under 35	U.S.C. 118
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Residence	e Infor	mation (Selec	ct One)	US Res	idency	Non U	S Reside	ncv	<u> </u>	Active US M	lititary Sen	/ice
City				Province					T	Country	T	
	p unde	er 37 CFR 1.4			<u> </u>					/		
		of Applicant										
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Applicant	4											
Applicant		rity 🗌	Legal R	Representati	ve under 35 L	.S.C. 11	17			Party of Inte	rest unde	r 35 U.S.C.
Inventor								<u> </u>	118	u	T = ==	
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Residence Information (Select One) US Residency Non US Residency Active US Military Service												
City State/Province Country												
Citizenship under 37 CFR 1.41(b)												
Mailing Address of Applicant(s):												
Address 1												
Address 2	!					<u> </u>						·—·
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